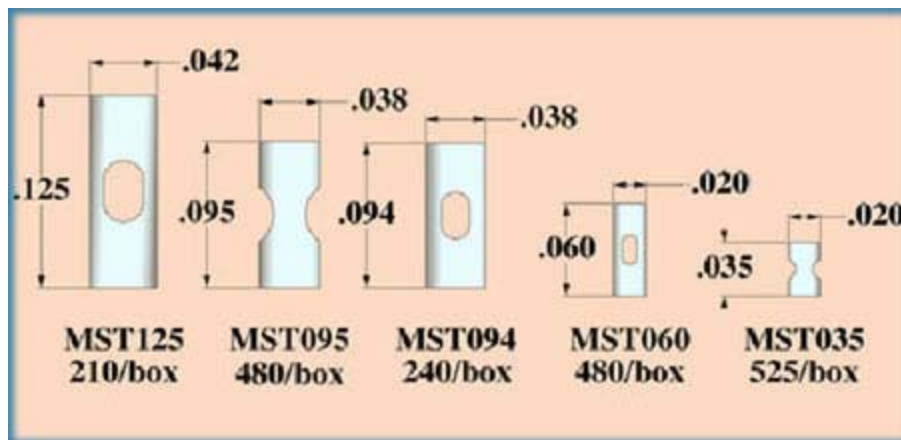


Bondable Terminals

Micron's Bondable terminals are specially designed for use in strain gage circuits. They are manufactured from 0.14 thick copper clad epoxy glass. The epoxy glass insures superior electrical insulation. These bondable terminals are flexible, strong and capable of high temperatures up to 275° F. Micron offers different sizes of bondable terminals to suit varying transducer applications.

Micron's bondable terminals are convenient junction points for connecting single or multiple strain gages to larger instrumentation leads. It has become common practice to employ bondable terminals between the main lead wires of larger diameter and the small delicate strain gage leads. The solder tab serves as a thermal barrier permitting a higher temperature for the larger wire solder joint without loss of degradation to the strain gage leads. The primary purpose is to provide an anchor and thermal barrier for both sets of leads.

Bondable Terminal Options

Bondable Terminal Price List

MST 125	\$15.00 per box
MST 095	\$12.00 per box
MST 094	\$15.00 per box
MST 060	\$15.00 per box
MST 035	\$22.00 per box

Terms & Conditions

Minimum Order: \$50.00
FOB: Simi Valley, California
Terms: Net 30 Days
 Credit Cards: Visa, Master Card, American Express
Effective Date: March 2008

Prices Subject to Change without Notice

Issue Date March 2008